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74VCX08

Low Voltage Quad 2-Input AND Gate with 3.6V Tolerant Inputs and Outputs

Features

- 1.2V to 3.6V V_{CC} supply operation
- 3.6V tolerant inputs and outputs
- t_{PD} :
 - 2.8ns max. for 3.0V to 3.6V V_{CC}
- Power-off high impedance inputs and outputs
- Static Drive (I_{OH}/I_{OL})
 - $\pm 24\text{mA}$ @ 3.0V V_{CC}
- Uses proprietary Quiet Series™ noise/EMI reduction circuitry
- Latchup performance exceeds 300mA
- ESD performance:
 - Human body model > 2000V
 - Machine model > 250V
- Leadless DQFN package

General Description

The VCX08 contains four 2-input AND gates. This product is designed for low voltage (1.2V to 3.6V) V_{CC} applications with I/O compatibility up to 3.6V.

The VCX08 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining low CMOS power dissipation.

Ordering Information

Order Number	Package Number	Package Description
74VCX08M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74VCX08BQY ⁽¹⁾	MLF14A	14-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 3.0mm
74VCX08MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Note:

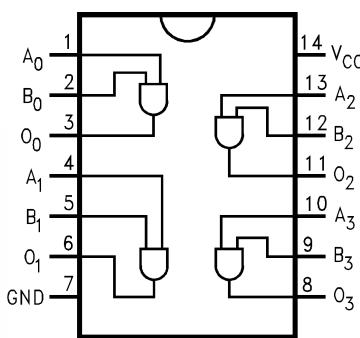
1. DQFN package available in Tape and Reel only.

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

 All packages are lead free per JEDEC: J-STD-020B standard.

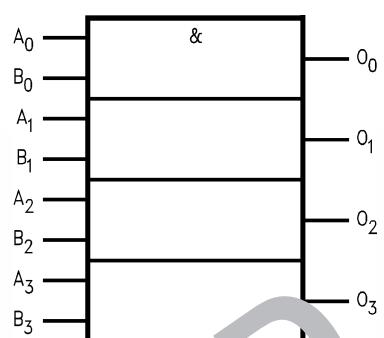
Connection Diagrams

Pin Assignments for SOIC and TSSOP

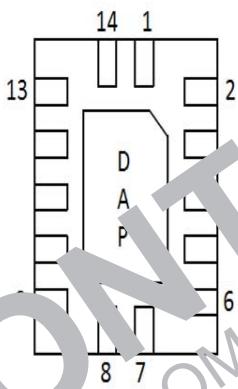
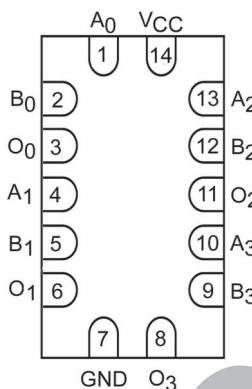


Logic Symbol

IEEE/IEC



Pad Assignments for DQFN



(Top View)

(Bottom View)

Pin Description

Pin Number	Description
A ₀ to B _n	Inputs
O _n	Outputs
DAP	No Connect

Note: DAP (Die Attach Pad)

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V_{CC}	Supply Voltage	-0.5V to +4.6V
V_I	DC Input Voltage	-0.5V to 4.6V
V_O	DC Output Voltage HIGH or LOW State ⁽²⁾	-0.5V to $V_{CC} + 0.5V$
	$V_{CC} = 0V$	-0.5V to +4.6V
I_{IK}	DC Input Diode Current, $V_I < 0V$	-50mA
I_{OK}	DC Output Diode Current $V_O < 0V$	-50mA
	$V_O > V_{CC}$	+50mA
I_{OH} / I_{OL}	DC Output Source/Sink Current	+50mA
I_{CC} or GND	DC V_{CC} or Ground Current per Supply Pin	$\pm 100mA$
T_{STG}	Storage Temperature Range	-65°C to +150°C

Note:

2. I_O Absolute Maximum Rating must be observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are selected to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or design up to absolute maximum ratings.

Symbol	Parameter	Rating
V_{CC}	Supply Operating	1.2V to 3.6V
V_I	Input Voltage	-0.3V to 3.6V
V_O	Output Voltage, HIGH or LOW State	0V to V_{CC}
I_O / I_C	Output Current $V_{CC} = 3.0V$ to 3.6V	$\pm 24mA$
	$V_{CC} = 2.3V$ to 2.7V	$\pm 18mA$
	$V_{CC} = 1.65V$ to 2.3V	$\pm 6mA$
	$V_{CC} = 1.4V$ to 1.6V	$\pm 2mA$
	$V_{CC} = 1.2V$	$\pm 100\mu A$
T_A	Free Air Operating Temperature	-40°C to +85°C
$\Delta t / \Delta V$	Minimum Input Edge Rate, $V_{IN} = 0.8V$ to 2.0V, $V_{CC} = 3.0V$	10ns/V

Note:

3. Floating or unused inputs must be held HIGH or LOW

DC Electrical Characteristics

Symbol	Parameter	V _{CC} (V)	Conditions	Min	Max	Units
V _{IH}	HIGH Level Input Voltage	2.7–3.6		2.0		V
		2.3–2.7		1.6		
		1.65–2.3		0.65 × V _{CC}		
		1.4–1.6		0.65 × V _{CC}		
		1.2		0.65 × V _{CC}		
V _{IL}	LOW Level Input Voltage	2.7–3.6			0.8	V
		2.3–2.7			0.7	
		1.65–2.3			0.35 × V _{CC}	
		1.4–1.6			0.35 × V _{CC}	
		1.2			0.05 × V _{CC}	
V _{OH}	HIGH Level Output Voltage	2.7–3.6	I _{OH} = -100µA	V _{CC} = 0.2		V
		2.7	I _{OH} = -12mA	2		
		3.0	I _{OH} = -18mA	2		
		3.0	I _{OH} = -24mA	2.2		
		2.3–2.7	I _{OH} = -100µA	V _{CC} = 0.2		
		2.3	I _{OH} = -12mA	2.0		
		2.3	I _{OH} = -18mA	1.8		
		2.3	I _{OH} = -18mA	1.7		
		2.5–2.7	I _{OH} = -100µA	V _{CC} = 0.2		
		1.65	I _{OH} = -6mA	1.25		
		1.4–1.6	I _{OH} = -100µA	V _{CC} = 0.2		
		1.4	I _{OH} = -2mA	1.05		
		1.2	I _{OH} = -100µA	V _{CC} = 0.2		
V _{OL}	LOW Level Output Voltage	2.7–3.6	I _{OL} = 100µA		0.2	V
		2.7	I _{OL} = 12mA		0.4	
		3.0	I _{OL} = 18mA		0.4	
		3.0	I _{OL} = 24mA		0.55	
		2.3–2.7	I _{OL} = 100µA		0.2	
		2.3	I _{OL} = 12mA		0.4	
		2.3	I _{OL} = 18mA		0.6	
		1.65–2.3	I _{OL} = 100µA		0.2	
		1.65	I _{OL} = 6mA		0.2	
		1.4–1.6	I _{OL} = 100µA		0.2	
		1.4	I _{OL} = 2mA		0.35	
		1.2	I _{OL} = 100µA		0.05	
I _I	Input Leakage Current	1.2–3.6	0 ≤ V _I ≤ 3.6V		±5.0	µA
I _{OFF}	Power-OFF Leakage Current	0	0 ≤ (V _I , V _O) ≤ 3.6V		10	µA
I _{CC}	Quiescent Supply Current	1.2–3.6	V _I = V _{CC} or GND		20	µA
			V _{CC} ≤ V _I ≤ 3.6V		±20	
ΔI _{CC}	Increase in I _{CC} per Input	2.7–3.6	V _{IH} = V _{CC} - 0.6V		750	µA

AC Electrical Characteristics⁽⁴⁾

Symbol	Parameter	V _{CC} (V)	Conditions	T _A = -40°C to +85°C		Units	Figure Number
				Min.	Max.		
t _{PHL} , t _{PLH}	Propagation Delay	3.3 ± 0.3	C _L = 30pF, R _L = 500Ω	0.6	2.8	ns	Fig. 1 Fig. 2
		2.5 ± 0.2		0.8	3.7		
		1.8 ± 0.15		1.0	7.4		Fig. 3 Fig. 4
		1.5 ± 0.1	C _L = 15pF, R _L = 2kΩ	1.0	14.8		
		1.2		1.5	37.0		
t _{OShL} , t _{OSLH}	Output to Output Skew ⁽⁵⁾	3.3 ± 0.3	C _L = 30pF, R _L = 500Ω		0.5		
		2.5 ± 0.2			0.5		
		1.8 ± 0.15			0.75		
		1.5 ± 0.1	C _L = 15pF, R _L = 2kΩ		1.0		
		1.2			5		

Note:

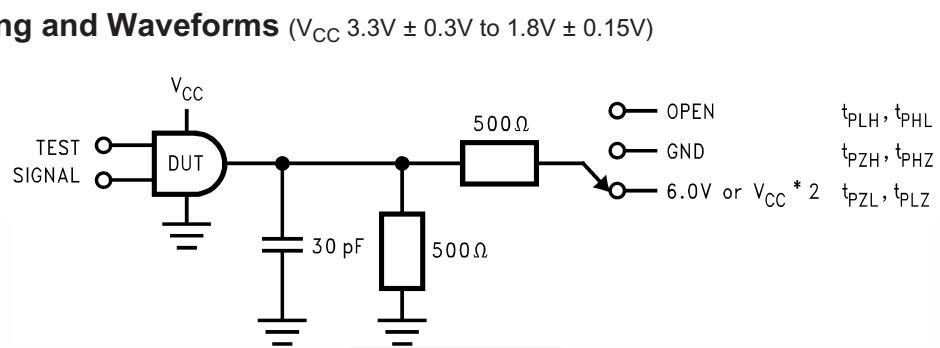
- For C_L = 50pF, add approximately 300ps to the AC Maximum specification.
- Skew is defined as the absolute value of the difference between the total propagation delay for any two separate outputs of the same device. The specification applies to any output switching in the same direction, either HIGH-to-LOW (t_{OShL}) or LOW-to-HIGH (t_{OSLH}).

Dynamic Switching Characteristics

Symbol	Parameter	V _{CC} (V)	Conditions	T _A = 25°C		Unit
				Typical	Unit	
V _{OLP}	Quiet Output Dynamic Peak V _{OL}	1.8	C _L = 30pF, V _{IH} = V _{CC} , V _{IL} = 0V	0.25	V	
		2.5		0.6		
		3.3		0.8		
V _{OLV}	Quiet Output Dynamic Valley V _{OL}	1.8	C _L = 30pF, V _{IH} = V _{CC} , V _{IL} = 0V	-0.25	V	
		2.5		-0.6		
		3.3		-0.8		
V _{OHV}	Quiet Output Dynamic Valley V _{OH}	1.8	C _L = 30pF, V _{IH} = V _{CC} , V _{IL} = 0V	1.5	V	
		2.5		1.9		
		3.3		2.2		

Capacitance

Symbol	Parameter	Conditions	T _A = +25°C		Units
			Typical	Unit	
C _{IN}	Input Capacitance	V _I = 0V or V _{CC} , V _{CC} = 1.8V, 2.5V or 3.3V	6.0	pF	
C _{OUT}	Output Capacitance	V _I = 0V or V _{CC} , V _{CC} = 1.8V, 2.5V or 3.3V	7.0	pF	
C _{PD}	Power Dissipation Capacitance	V _I = 0V or V _{CC} , f = 10MHz, V _{CC} = 1.8V, 2.5V or 3.3V	20.0	pF	



Test	Switch
t_{PLH}, t_{PHL}	Open

Figure 1. AC Test Circuit

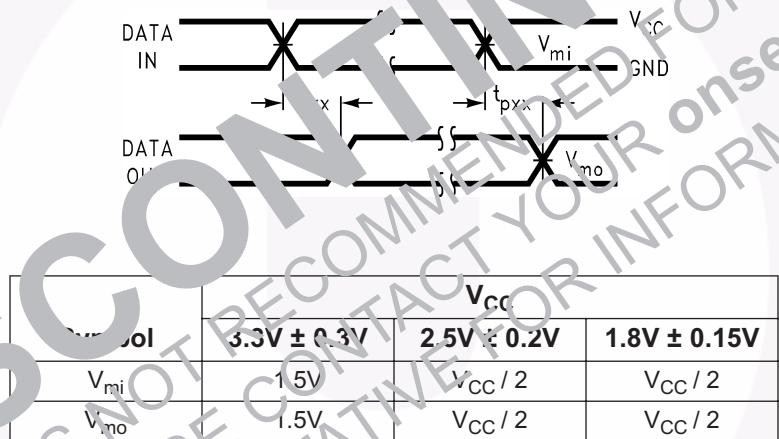
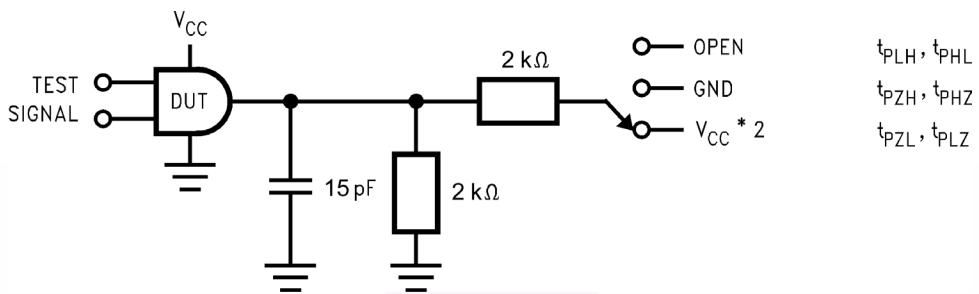


Figure 2. Waveform for Inverting and Non-inverting Functions

AC Loading and Waveforms (V_{CC} 1.5 ± 0.1V to 1.2V)

Test	Switch
t_{PLH}, t_{PHL}	Open
t_{PZH}, t_{PHZ}	$V_{CC} * 2$ at $V_{CC} = 1.5V \pm 0.1V$
t_{PZL}, t_{PLZ}	GND

Figure 3. AC Test Circuit

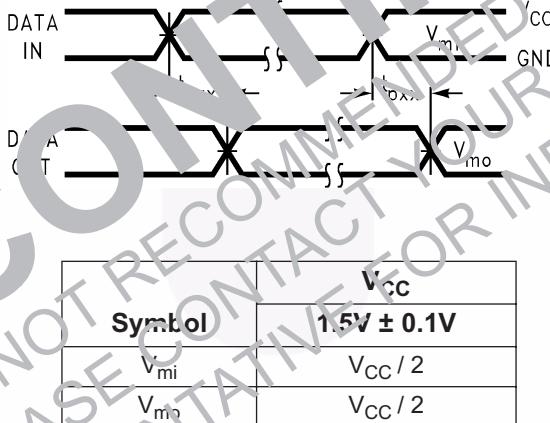


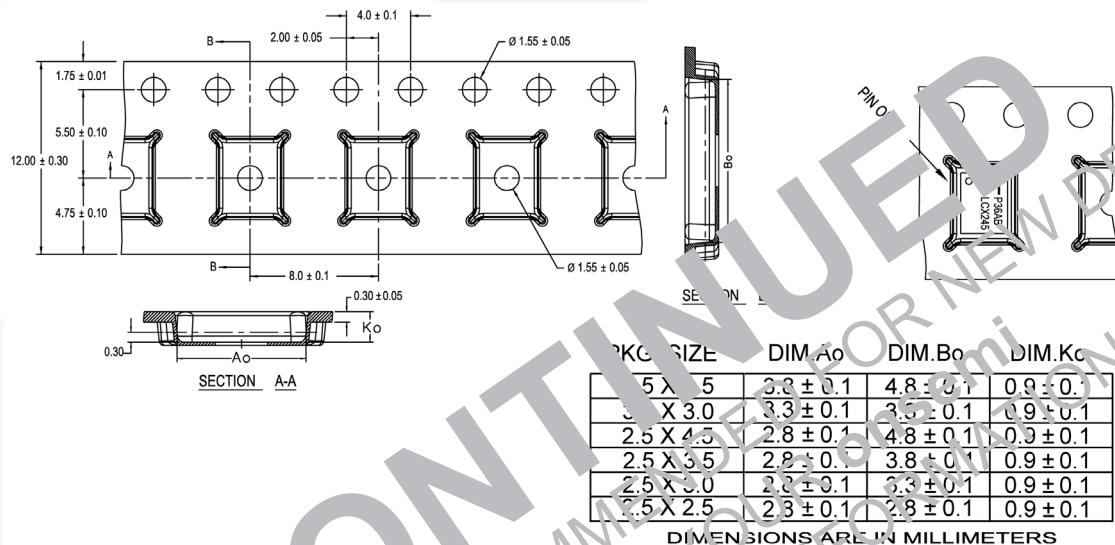
Figure 4. Wavelength for Inverting and Non-Inverting Functions

Tape and Reel Specification

Tape Format for DQFN

Package Designator	Tape Section	Number of Cavities	Cavity Status	Cover Tape Status
BQX	Leader (Start End)	125 (Typ.)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typ.)	Empty	Sealed

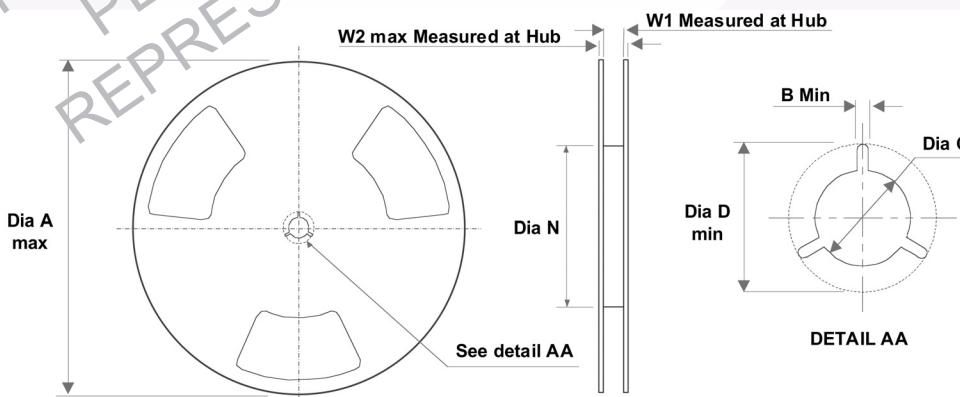
Tape Dimensions inches (millimeters)



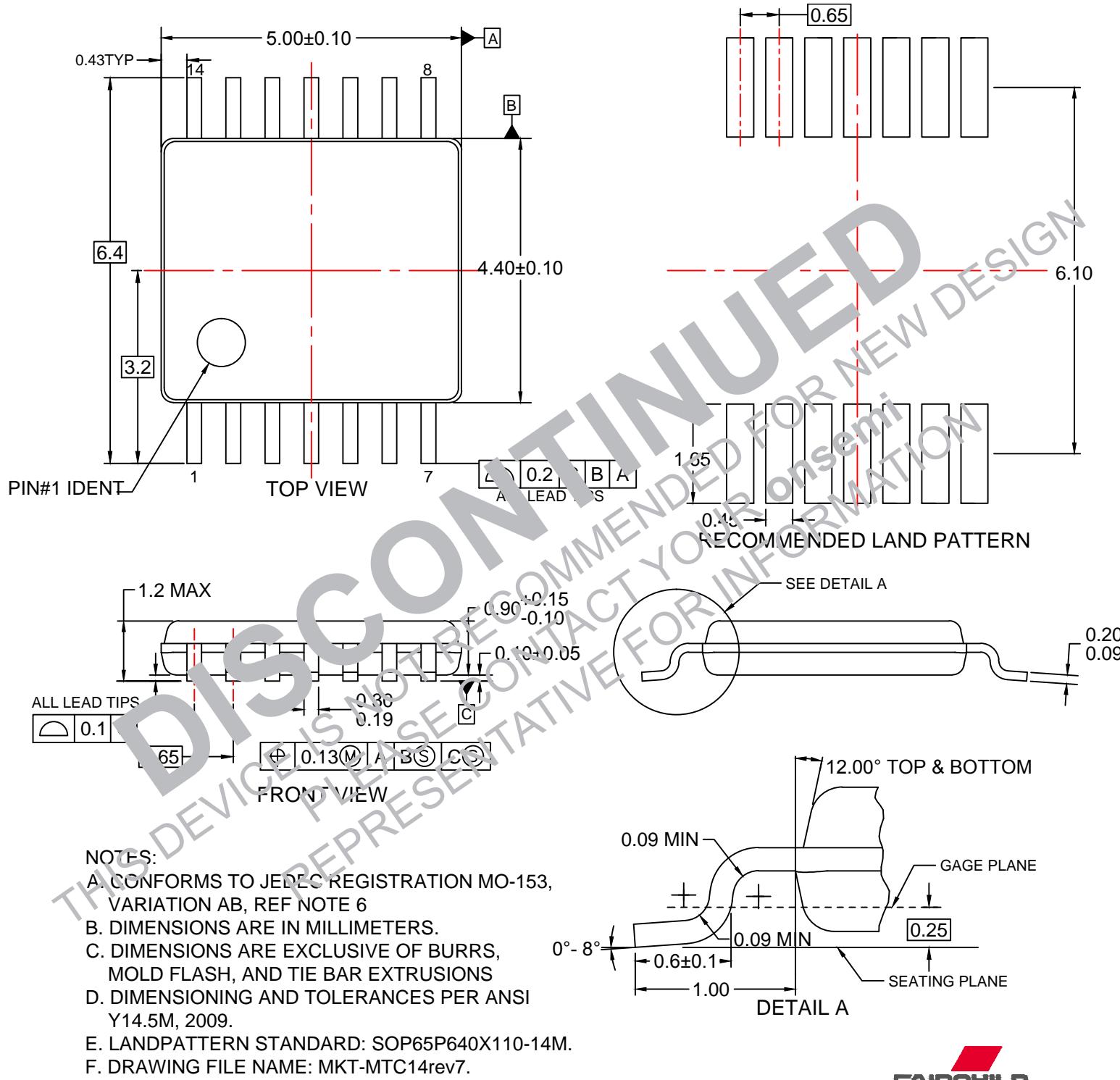
NOTES: unless otherwise specified

1. Cumulative pitch for feeding holes and cavities (chip pockets) not to exceed 0.00%[0.20] over 10 pitch span.
2. Smallest allowable bending radius is.
3. Thru hole inside cavity is centered within cavity.
4. Tolerance is ± 0.002[± 0.05] on these dimensions on all 12mm tapes.
5. Kc and Ao measured on a plane 0.120[0.30] above the bottom of the pocket.
6. Kd measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
7. Pocket position relative to sprue hole measured as true position of pocket. Not pocket hole.
8. Controlling dimension is millimeter. Dimension in inches rounded.

Reel Dimensions inches (millimeters)



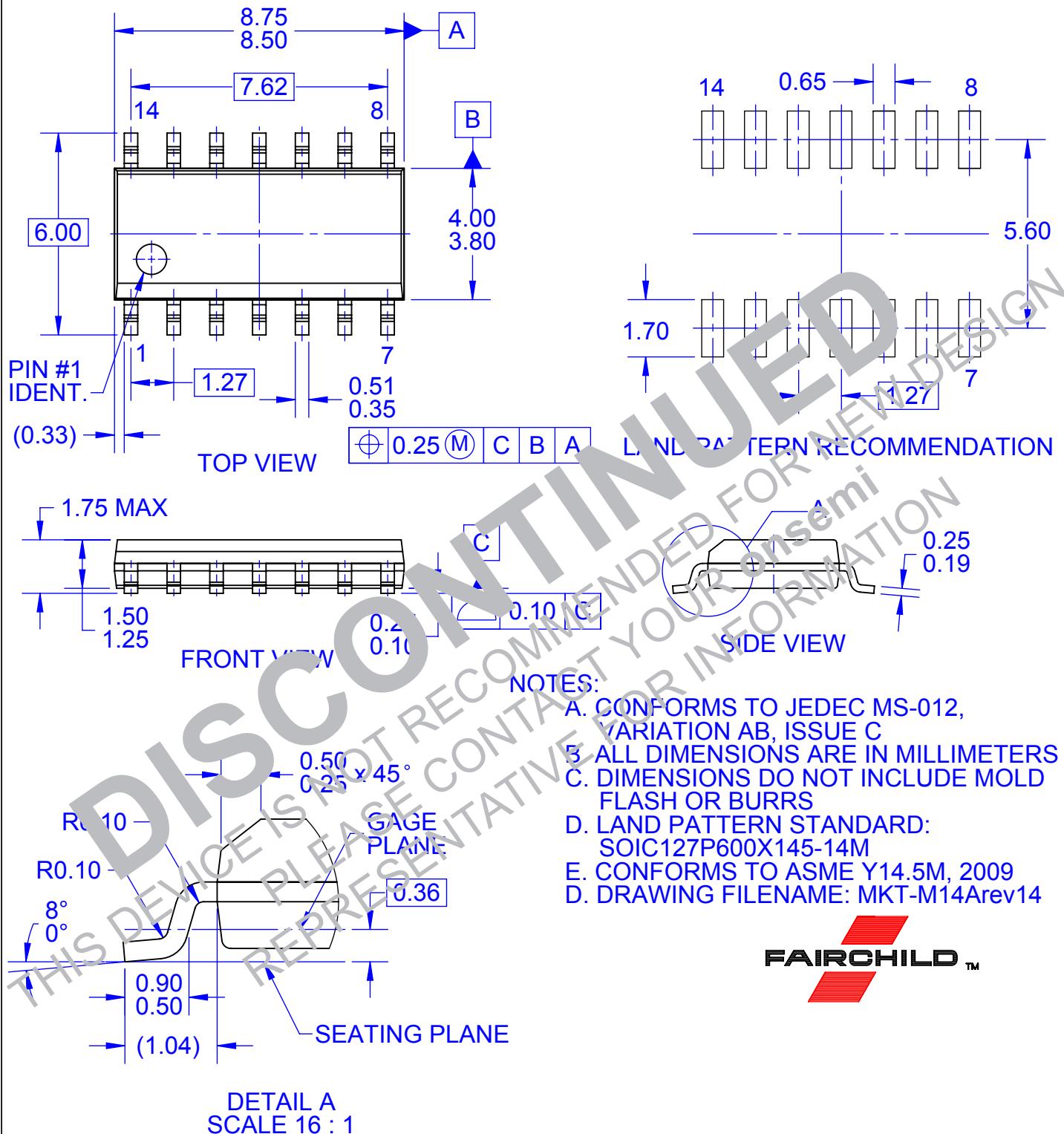
Tape Size	A	B	C	D	N	W1	W2
12mm	13.0 (330.0)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	0.488 (12.4)	0.724 (18.4)

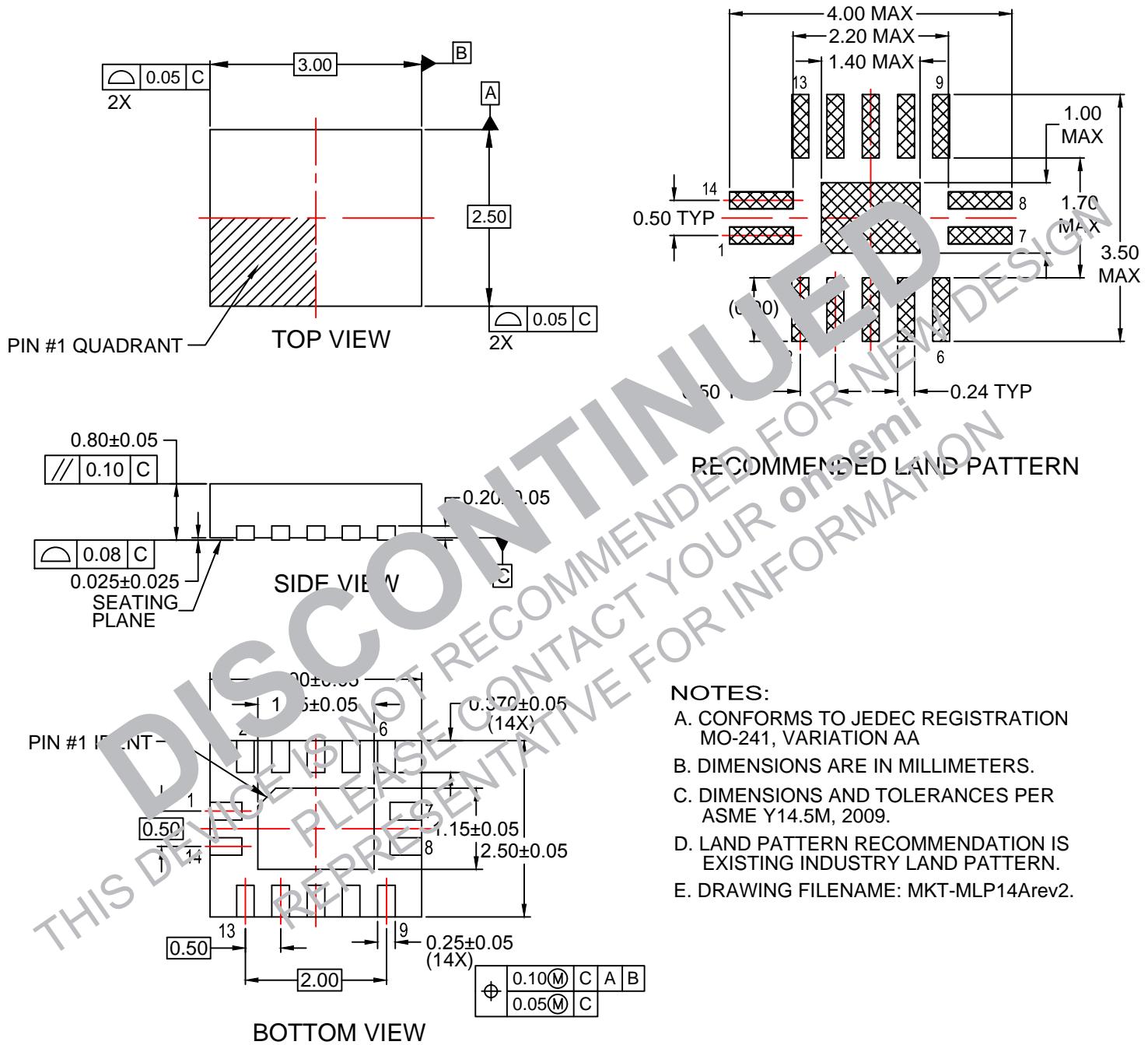


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- F. DRAWING FILE NAME: MKT-MTC14rev7.

The Fairchild logo consists of the word "FAIRCHILD" in a bold, black, sans-serif font. Above the letter "F", there is a red, slanted parallelogram. Below the letter "L", there is a second red, slanted parallelogram that overlaps the "I" and "C".





NOTES:

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